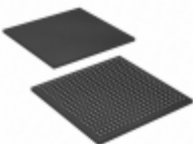


Spezifikationen	
Artikelnummer	A2F200M3F-FG256I
Hersteller	Microsemi
Beschreibung	IC FPGA 200K GATES 256KB 256-BGA
Kategorie	Integrierte Schaltungen (ICs) > Eingebettet - System On
Teilstatus	651 pcs Stock
Supplier Device-Gehäuse	256-FPBGA (17x17)
Geschwindigkeit	80MHz
Serie	SmartFusion®
Primärattribut	ProASIC®3 FPGA, 200K Gates, 4608 D-Flip-Flops
Peripherals	DMA, POR, WDT
Verpackung	Tray
Verpackung / Gehäuse	256-LBGA
Betriebstemperatur	-40°C ~ 100°C (TJ)
Anzahl der E / A	MCU - 25, FPGA - 66
MCU RAM	64KB
MCU-Flash	256KB
Core-Prozessor	ARM® Cortex®-M3
Connectivity	EBI/EMI, Ethernet, I²C, SPI, UART/USART
Die Architektur	MCU, FPGA

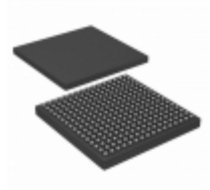
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A2F200M3F-FG256
Microsemi Corporation
IC FPGA 200K GATES 256KB 256-
BGA

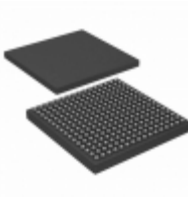

A2F200M3F-CS288I
Microsemi Corporation
IC FPGA 200K GATES 256KB 288-
CSP



A2F200M3F-FG484I
Microsemi Corporation
IC FPGA 200K GATES 256KB 484-BGA

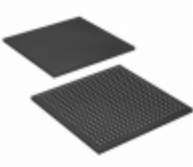


A2F200M3F-FGG256
Microsemi Corporation
IC FPGA 256K FLASH 256FBGA

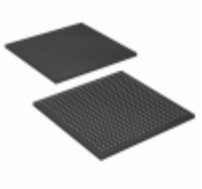


A2F200M3F-FGG256I
Microsemi Corporation
IC FPGA 200K GATES 256KB 256-
BGA


A2F200M3F-CSG288I
Microsemi Corporation
IC FPGA 200K GATES 256KB 288-
CSP



A2F200M3F-FG484
Microsemi Corporation
IC FPGA 200K GATES 256KB 484-BGA



Mehr

Contact us: **Info@YIC-Electronics.com**

HINZUFÜGEN: Einheit A5-B5 Nr. 509, 5 / F Sing Win-Fabrikgebäude, 15-17 Shing Yip Street, Kwun Tong, Kowloon, Hongkong.

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